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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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H7N0308LD, H7N0308LS, H7N0308LM

Silicon N Channel MOS FET
High Speed Power Switching

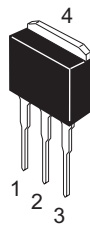
REJ03G1124-0500
(Previous: ADE-208-1535C)
Rev.5.00
Apr 07, 2006

Features

- Low on-resistance
 $R_{DS(on)} = 3.8 \text{ m}\Omega$ typ.
- Low drive current
- 4.5 V gate drive device can be driven from 5 V source

Outline

RENESAS Package code: PRSS0004AE-A
(Package name: LDKPAK (L))



H7N0308LD

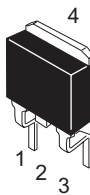
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(Package name: LDKPAK (S)-(1))



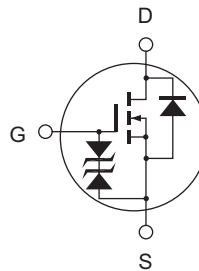
H7N0308LS

1. Gate
2. Drain
3. Source
4. Drain

RENESAS Package code: PRSS0004AE-C
(Package name: LDKPAK (S)-(2))



H7N0308LM



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	70	A
Drain peak current	$I_{D(pulse)}$ ^{Note 1}	280	A
Body to drain diode reverse drain current	I_{DR}	70	A
Channel dissipation	P_{ch} ^{Note 2}	100	W
Channel to case thermal impedance	θ_{ch-c}	1.25	°C/W
Channel to ambient thermal impedance	θ_{ch-a}	89	°C/W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$
 2. Value at $T_c = 25^\circ C$

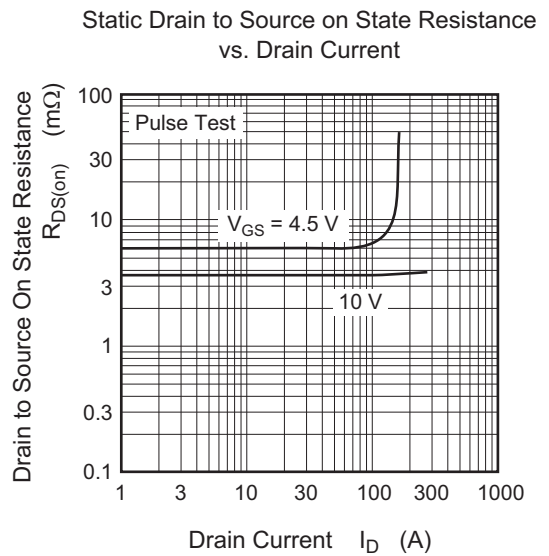
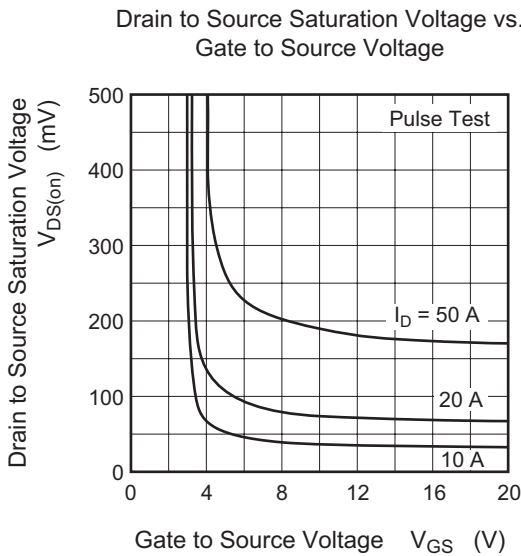
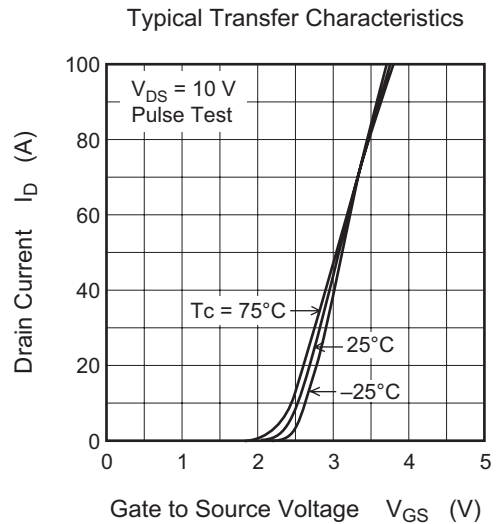
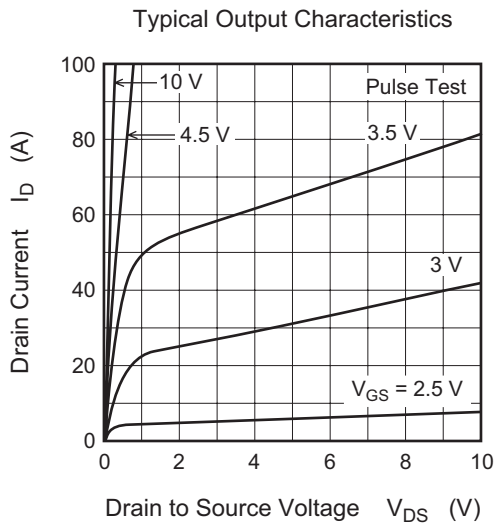
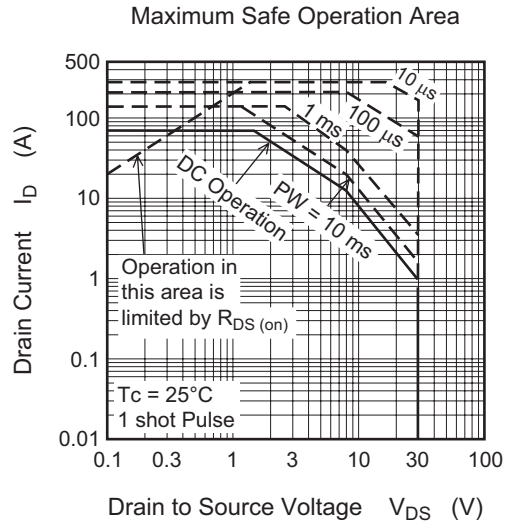
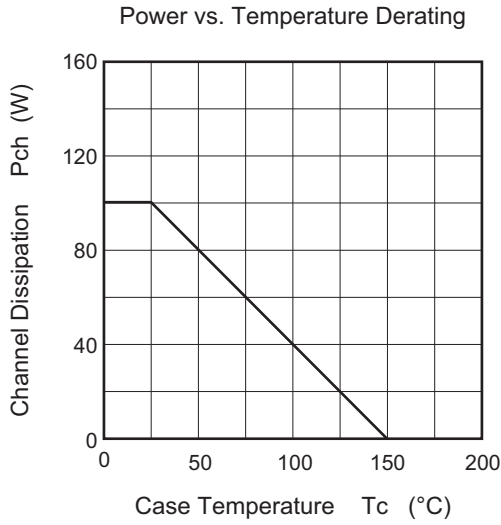
Electrical Characteristics

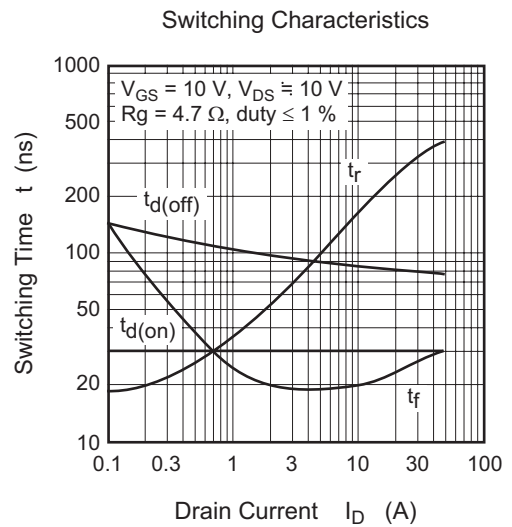
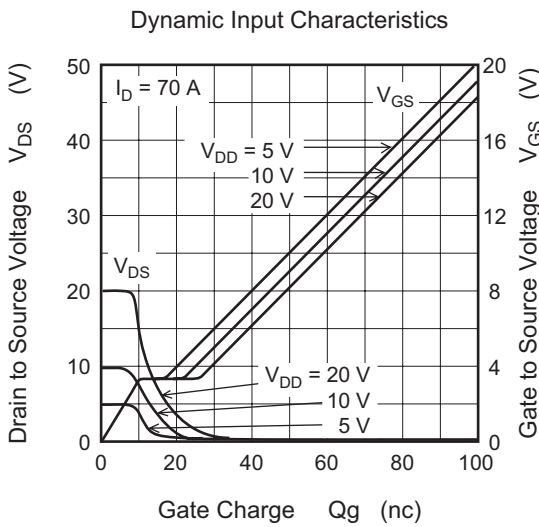
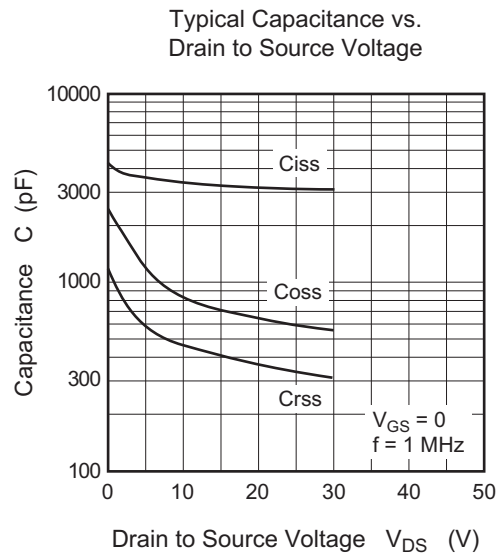
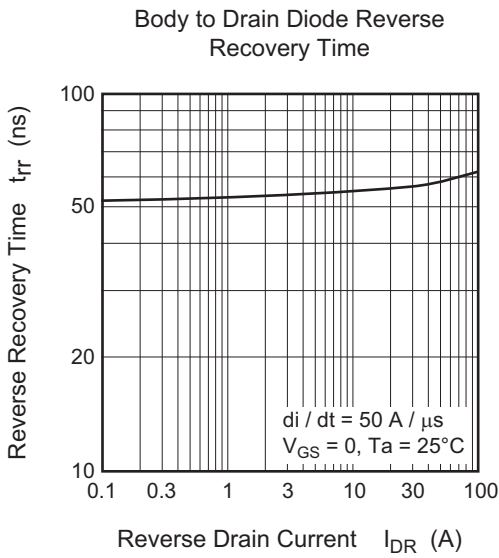
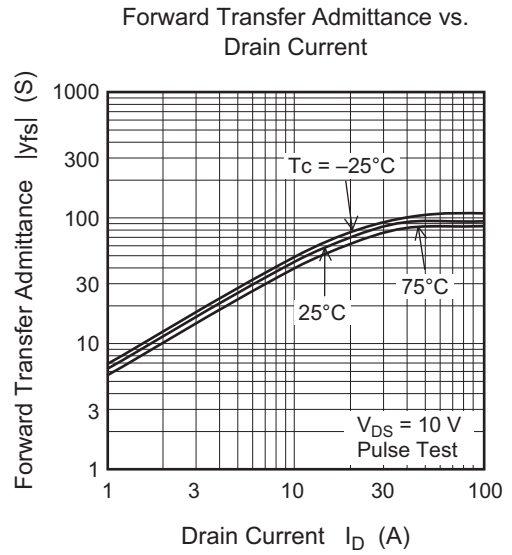
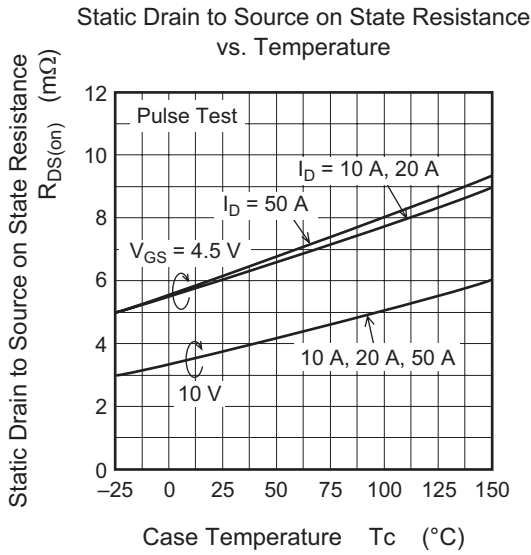
(Ta = 25°C)

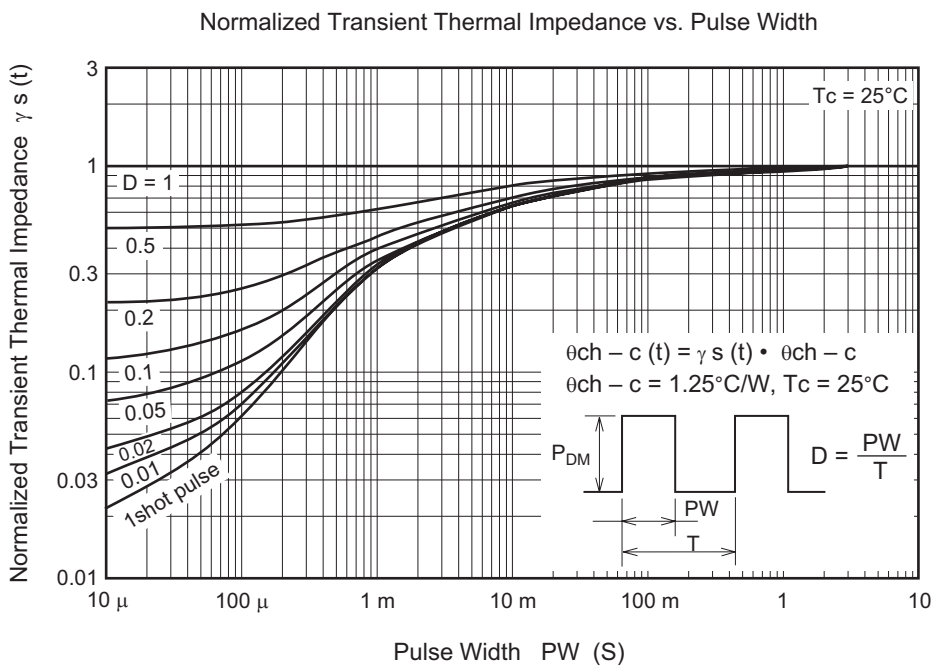
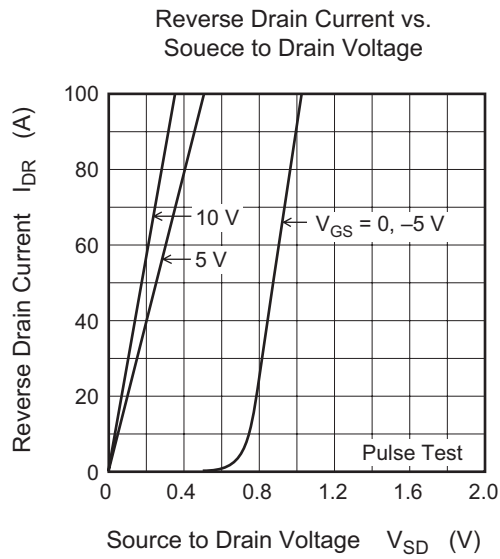
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100 \mu A$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 30 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.5	V	$I_D = 1 \text{ mA}$, $V_{DS} = 10 \text{ V}$ ^{Note 3}
Static drain to source on state resistance	$R_{DS(on)}$	—	3.8	4.8	mΩ	$I_D = 35 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note 3}
		—	6.0	8.5	mΩ	$I_D = 35 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note 3}
Forward transfer admittance	$ y_{fs} $	54	90	—	S	$I_D = 35 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note 3}
Input capacitance	C_{iss}	—	3350	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	840	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	480	—	pF	$f = 1 \text{ MHz}$
Total gate charge	Q_g	—	52	—	nC	$V_{DD} = 10 \text{ V}$
Gate to source charge	Q_{gs}	—	11	—	nC	$V_{GS} = 10 \text{ V}$
Gate to drain charge	Q_{gd}	—	10	—	nC	$I_D = 70 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	30	—	ns	$V_{GS} = 10 \text{ V}$, $I_D = 35 \text{ A}$
Rise time	t_r	—	370	—	ns	$R_L = 0.29 \Omega$
Turn-off delay time	$t_{d(off)}$	—	80	—	ns	$R_g = 4.7 \Omega$
Fall time	t_f	—	27	—	ns	
Body to drain diode forward voltage	V_{DF}	—	0.93	—	V	$I_F = 70 \text{ A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	60	—	ns	$I_F = 70 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 50 \text{ A}/\mu s$

Note: 3. Pulse test

Main Characteristics



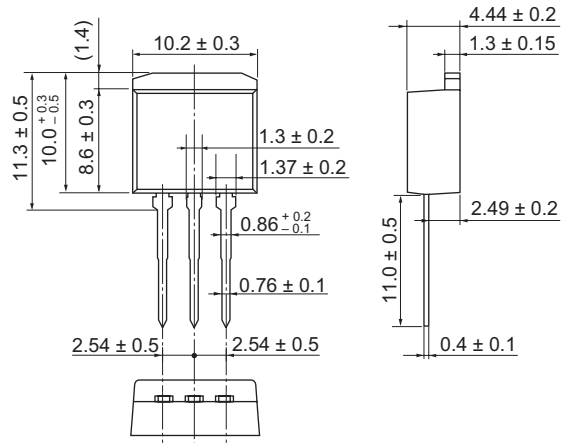




Package Dimensions

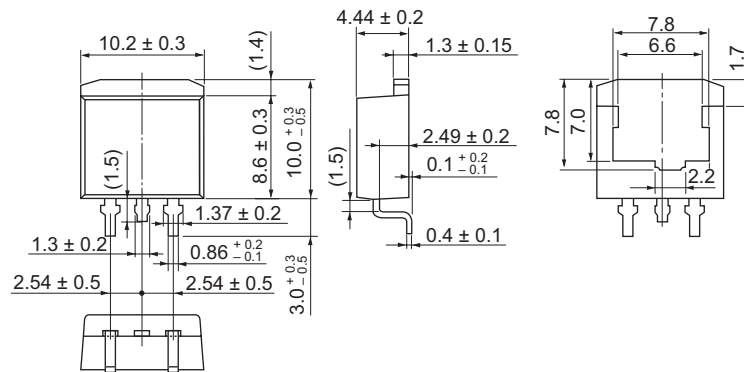
Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
LDBPAK(L)	—	PRSS0004AE-A	LDBPAK(L) / LDBPAK(L)V	1.40g

Unit: mm



Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
LDBPAK(S)-(1)	SC-83	PRSS0004AE-B	LDBPAK(S)-(1) / LDBPAK(S)-(1)V	1.30g

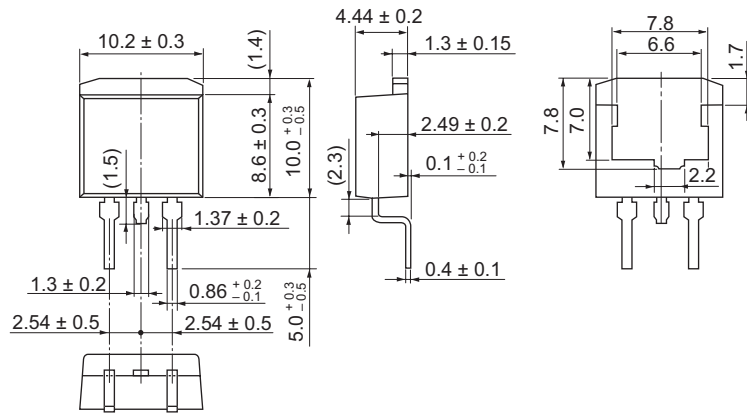
Unit: mm



H7N0308LD, H7N0308LS, H7N0308LM

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
LDBPAK(S)-(2)	—	PRSS0004AE-C	LDBPAK(S)-(2) / LDBPAK(S)-(2)V	1.35g

Unit: mm



Ordering Information

Part Name	Quantity	Shipping Container
H7N0308LD-E	500 pcs	Box (Conductive Sack)
H7N0308LSTL-E	1000 pcs	Taping
H7N0308LMTL-E	1000 pcs	Taping

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